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Bv:

Date: **ftb 14, 4**

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant

: Bernhard Schaetzler et al.

Applic. No.

: 09/688,465

Filed

: October 16, 2000

Title

: Electronic Component With An Integrated

Circuit Mounted On An Island Of A Lead Frame

Examiner

: Nitiin Parekh

Group Art Unit: 2811

AMENDMENT

Hon. Commissioner of Patents and Trademarks, Washington, D. C. 20231

Sir:

Responsive to the Office action dated November 18, 2002 kindly amend the above-identified application as follows:

In the Claims:

Claim 1 (amended). An electronic component, comprising:

BI

a thin quad flat package including:

03/06/2003 SSESHE1 00000058 09688465

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